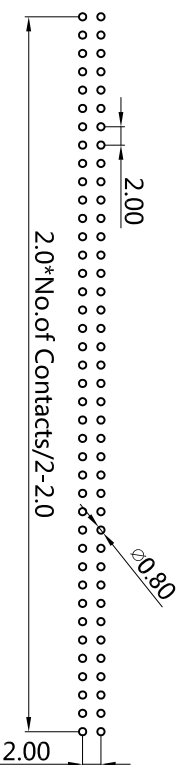
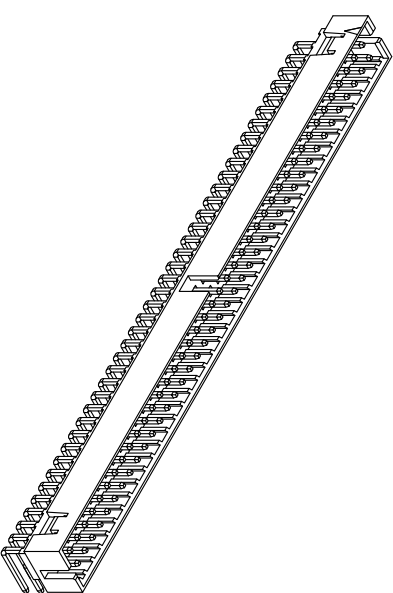
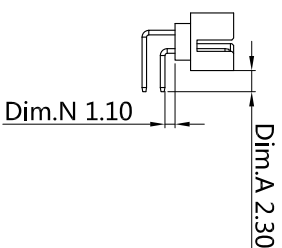
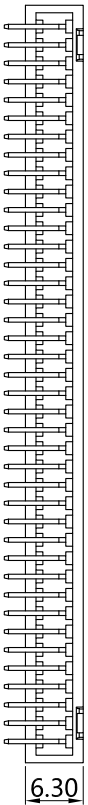
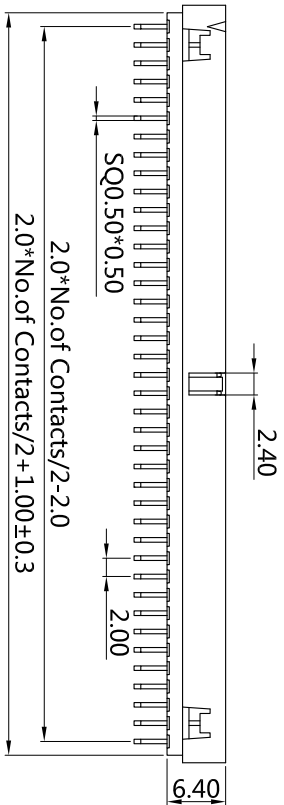
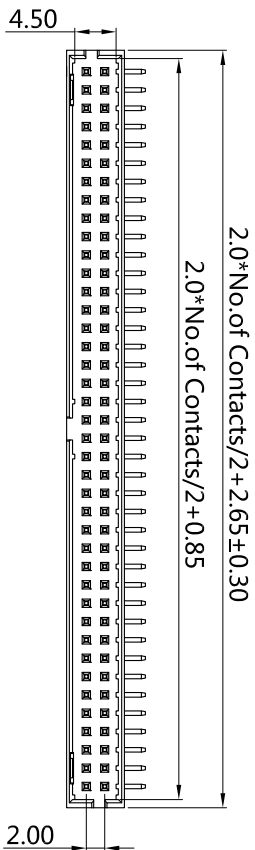


1	2	3	4	5	6	7	8



Recommended P.C. Board
SMD Layout

Current Rating: 2 Amps
 Insulator Resistance: 1000 Megohms min
 Dielectric Withstanding: AC 500V
 Contact Resistance: 20mΩ MAX
 Operation Temperature: -40~+105°C
 Max processing temp: 230°C for 60seconds
 Max processing temp: 260°C for 10seconds
 Contact Material: Brass
 Insulator material: Standard: Polyester, UL 94V-0
 Standard: LCP
 Finish: Tin Gold Plated
 Standard: Gold Flash all over

BH22 X - XX R0 BK X 000 X
 1 2 3 4 5 6 7

1. Insulator material:

- N=PA6T
- L=LCP P=PA9T
- 2. Circuits: 4-50PIN
- 3. Tail Style: R0= Right Angle
- 4. Color: BK=Black

5. Contact Plated:

- T=Matte Tin over Nickel
- W=Matte Tin over nickel 150μ"
- Y=Bright Tin over Nickel
- F=Gold Flash, Matte Tin 100μ"
- A=Gold 3μ"
- B=Gold 3μ"
- C = ordinary gold plating
- D = Gold 5μ"

6.Special Options

- D= Gold 5μ"
- I=Gold 1μ"
- G=Gold 10μ"
- J=Gold 10μ"
- L = Gold 15μ"
- M=Gold 15μ"
- U = Gold 30μ"
- V=Gold 30μ"

7. Packing:

- A=Bag
- B=Tube
- C=Tray
- E=Cap+Reel
- F=Cap+tube
- G=Cap+tray
- H=Cap+bag
- N=Tap&reel



东莞市震升电子有限公司
DONG GUAN ZHEN SHENG ELECTRONICS CO., LTD

1:	BH22X-XXBKHC2
2:	SQ0.50-11.4/15.4-X-C12
3:	

PART NO.	BH22X-XXR0BKX000X	X	.XX	.XXX
DRAWING NO	BA-00099	±0.30	±0.20	±0.1
DRAWN BY	Deng jin quan	EDITION:A1	ITEM: BH22	SCALE:1:1
APPROVAL BY	Chen xiao guang	2021-12-21	2021-12-22	UNIT:M.M

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